

FEATURES

- **Single Chip Provides Complete LocalTalk®/AppleTalk Port**
- **Operates From a Single 5V Supply**
- ESD Protection to $\pm 10\text{kV}$ on Receiver Inputs and Driver Outputs
- **Low Power: $I_{CC} = 2.4\text{mA}$ Typ**
- Shutdown Pin Reduces I_{CC} to $0.5\mu\text{A}$ Typ
- Receiver Keep-Alive Function: $I_{CC} = 65\mu\text{A}$ Typ
- **Differential Driver Drives Either Differential AppleTalk or Single-Ended EIA562 Loads**
- Drivers Maintain High Impedance in Three-State or with Power Off
- Thermal Shutdown Protection
- Drivers are Short-Circuit Protected

APPLICATIONS

- LocalTalk Peripherals
- Notebook/Palmtop Computers
- Battery-Powered Systems

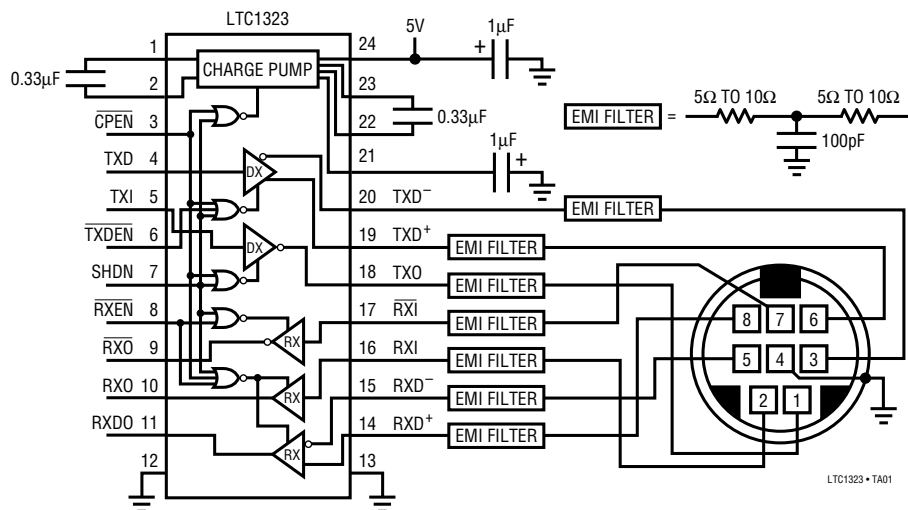
DESCRIPTION

The LTC®1323 is a multi-protocol line transceiver designed to operate on AppleTalk or EIA562-compatible single-ended networks while operating from a single 5V supply. There are two versions of the LTC1323 available: a 16-pin version designed to connect to an AppleTalk network, and a 24-pin version which also includes the additional single-ended drivers and receivers necessary to create an Apple-compatible serial port. An on-board charge pump generates a -5V supply which can be used to power external devices. Additionally, the 24-pin LTC1323 features a micropower keep-alive mode during which one of the single-ended receivers is kept active to monitor external wake-up signals. The LTC1323 draws only 2.4mA quiescent current when active, $65\mu\text{A}$ in receiver keep-alive mode, and $0.5\mu\text{A}$ in shutdown, making it ideal for use in battery-powered systems.

The differential driver can drive either differential AppleTalk loads or conventional single-ended loads. The driver outputs three-state when disabled, during shutdown, in receiver keep-alive mode, or when the power is off. The driver outputs will maintain high impedance even with output common-mode voltages beyond the power supply rails. Both the driver outputs and receiver inputs are protected against ESD damage to $\pm 10\text{kV}$.

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TYPICAL APPLICATION



ABSOLUTE MAXIMUM RATINGS

Supply Voltage (V_{CC})	7V	Driver Short-Circuit Duration	Indefinite
Input Voltage		Operating Temperature Range	0°C to 70°C
Logic Inputs	-0.3V to $V_{CC} + 0.3V$	Storage Temperature Range	-65°C to 150°C
Receiver Inputs	$\pm 15V$	Lead Temperature (Soldering, 10 sec)	300°C
Driver Output Voltage (Forced)	$\pm 15V$		

PACKAGE/ORDER INFORMATION

<p>TOP VIEW</p> <p>G PACKAGE 28-LEAD PLASTIC SSOP $T_{JMAX} = 150^{\circ}C, \theta_{JA} = 96^{\circ}C/W$</p>	<p>ORDER PART NUMBER</p> <p>LTC1323CG</p>	<p>TOP VIEW</p> <p>S PACKAGE 16-LEAD PLASTIC SO $T_{JMAX} = 125^{\circ}C, \theta_{JA} = 85^{\circ}C/W$</p>	<p>ORDER PART NUMBER</p> <p>LTC1323CS</p>
<p>TOP VIEW</p> <p>SW PACKAGE 24-LEAD PLASTIC SO WIDE $T_{JMAX} = 125^{\circ}C, \theta_{JA} = 85^{\circ}C/W$</p>	<p>ORDER PART NUMBER</p> <p>LTC1323CSW</p>		

Consult factory for Industrial and Military grade parts.

ELECTRICAL CHARACTERISTICS

 $V_{CC} = 5V \pm 10\%$, $T_A = 0^\circ C$ to $70^\circ C$ (Notes 2, 3)

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Supplies							
I _{CC}	Normal Operation Supply Current	No Load, SHDN = 0V, \overline{CPEN} = 0V, \overline{TXDEN} = 0V, \overline{RXEN} = 0V	●		2.4	4	mA
	Receiver Keep-Alive Supply Current	No Load, SHDN = 0V, \overline{CPEN} = V _{CC} , \overline{TXDEN} = 0V, \overline{RXEN} = 0V	●		65	100	μA
	Shutdown Supply Current	No Load, SHDN = V _{CC} , \overline{CPEN} = X, \overline{TXDEN} = X, \overline{RXEN} = 0V	●		0.5	10	μA
V _{EE}	Negative Supply Output Voltage	I _{LOAD} ≤ 10mA (Note 4), V _{CC} = 5V, R _L = 100Ω (Figure 1), TXI = V _{CC} , R _{TXO} = 3k (Figure 5)	●	−5.5	−5	−4.5	V
f _{OSC}	Charge Pump Oscillator Frequency				200		kHz
Differential Driver							
V _{OD}	Differential Output Voltage	No Load R _L = 100Ω (Figure 1)	● ●	±8 ±2			V
ΔV _{OD}	Change in Magnitude of Differential Output Voltage	R _L = 100Ω (Figure 1)			0.2		V
Differential Driver							
V _{OC}	Differential Common-Mode Output Voltage	R _L = 100Ω			3		V
V _{OS}	Single-Ended Output Voltage	No Load R _L = 3k to GND	● ●	±4.0 ±3.7			V V
V _{CMR}	Common-Mode Range	SHDN = V _{CC} or \overline{CPEN} = V _{CC} or Power Off	●			±10	V
I _{SS}	Short-Circuit Current	−5V ≤ V _O ≤ 5V	●	35	120	500	mA
I _{OZ}	Three-State Output Current	SHDN = V _{CC} or \overline{CPEN} = V _{CC} or Power Off, −10V ≤ V _O ≤ 10V	●		±2	±200	μA
Single-Ended Driver (Note 5)							
V _{OS}	Single-Ended Output Voltage	No Load R _L = 3k to GND	● ●	±4.5 ±3.7			V V
V _{CMR}	Common-Mode Range	SHDN = V _{CC} or \overline{CPEN} = V _{CC} or \overline{TXDEN} = V _{CC} or Power Off	●			±10	V
I _{SS}	Short-Circuit Current	−5V ≤ V _O ≤ 5V	●	35	220	500	mA
I _{OZ}	Three-State Output Current	SHDN = V _{CC} or \overline{CPEN} = V _{CC} or \overline{TXDEN} = V _{CC} or Power Off, −10V ≤ V _O ≤ 10V	●		±2	±200	μA
Receivers							
R _{IN}	Input Resistance	−7V ≤ V _{IN} ≤ 7V	●	12			kΩ
	Differential Receiver Threshold Voltage	−7V ≤ V _{CM} ≤ 7V	●	−200		200	mV
	Differential Receiver Input Hysteresis	−7V ≤ V _{CM} ≤ 7V	●		70		mV
	Single-Ended Input, Low Voltage	(Note 5)	●			0.8	V
	Single-Ended Input, High Voltage	(Note 5)	●	2			V
V _{OH}	Output High Voltage	I _O = −4mA	●	3.5			V
V _{OL}	Output Low Voltage	I _O = 4mA	●			0.4	V
I _{SS}	Output Short-Circuit Current	−5V ≤ V _O ≤ 5V	●	7		85	mA
I _{OZ}	Output Three-State Current	−5V ≤ V _O ≤ 5V, \overline{RXEN} = V _{CC}	●		±2	±100	μA

ELECTRICAL CHARACTERISTICS

$V_{CC} = 5V \pm 10\%$, $T_A = 0^\circ\text{C}$ to 70°C (Notes 2 and 3)

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Logic Inputs							
V_{IH}	Input High Voltage	All Logic Input Pins	●	2.0			V
V_{IL}	Input Low Voltage	All Logic Input Pins	●			0.8	V
I_C	Input Current	All Logic Input Pins	●		± 1.0	± 20	μA
Switching Characteristics							
t_{PLH} , t_{PHL}	Differential Driver Propagation Delay	$R_L = 100\Omega$, $C_L = 100\text{pF}$ (Figures 2, 7)	●		40	120	ns
	Differential Driver Propagation Delay with Single-Ended Load	$R_L = 3k$, $C_L = 100\text{pF}$ (Figures 3, 9)	●		120	180	ns
	Single-Ended Driver Propagation Delay	$R_L = 3k$, $C_L = 100\text{pF}$, (Figures 5, 10) (Note 5)	●		40	120	ns
	Differential Receiver Propagation Delay	$C_L = 15\text{pF}$ (Figures 2, 11)	●		70	160	ns
	Single-Ended Receiver Propagation Delay	$C_L = 15\text{pF}$ (Figures 6, 12) (Note 5)	●		70	160	ns
	Inverting Receiver Propagation Delay in Keep-Alive Mode, $\text{SHDN} = 0V$, $\text{CPEN} = V_{CC}$	$C_L = 15\text{pF}$ (Figures 6, 12) (Note 5)	●		150	600	ns
t_{SKEW}	Differential Driver Output to Output	$R_L = 100\Omega$, $C_L = 100\text{pF}$ (Figures 2, 7)	●		10	50	ns
t_r , t_f	Differential Driver Rise/Fall Time	$R_L = 100\Omega$, $C_L = 100\text{pF}$ (Figures 2, 7)	●		50	150	ns
	Differential Driver Rise/Fall Time with Single-Ended Load	$R_L = 3k$, $C_L = 100\text{pF}$ (Figures 3, 9)	●		50	150	ns
	Single-Ended Driver Rise/Fall Time	$R_L = 3k$, $C_L = 100\text{pF}$ (Figures 5, 10) (Note 5)	●		15	80	ns
t_{HDIS} , t_{LDIS}	Differential Driver Output Active to Disable	$C_L = 15\text{pF}$ (Figures 4, 8)	●		180	250	ns
	Any Receiver Output Active to Disable	$C_L = 15\text{pF}$ (Figures 4, 13)	●		30	100	ns
t_{ENH} , t_{ENL}	Differential Driver Enable to Output Active	$C_L = 15\text{pF}$ (Figures 4, 8)	●		180	250	ns
	Any Receiver, Enable to Output Active	$C_L = 15\text{pF}$ (Figures 4, 13)	●		30	100	ns
V_{EER}	Supply Rise Time from Shutdown or Receiver Keep-Alive	$C1 = C2 = 0.33\mu\text{F}$, $C_{VEE} = 1\mu\text{F}$	●		0.2		ms

The ● denotes specifications which apply over the full operating temperature range.

Note 1: Absolute maximum ratings are those values beyond which the life of a device may be impaired.

Note 2: All currents into device pins are positive; all currents out of device pins are negative. All voltages are referenced to ground unless otherwise specified.

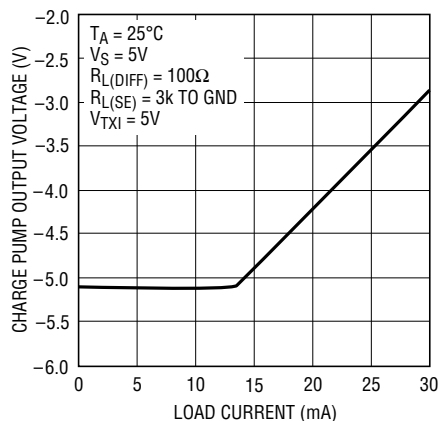
Note 3: All typicals are given at $V_{CC} = 5V$, $T_A = 25^\circ\text{C}$.

Note 4: I_{LOAD} is an external current being sunk into the V_{EE} pin.

Note 5: These specifications apply to the 24-pin SO Wide package only.

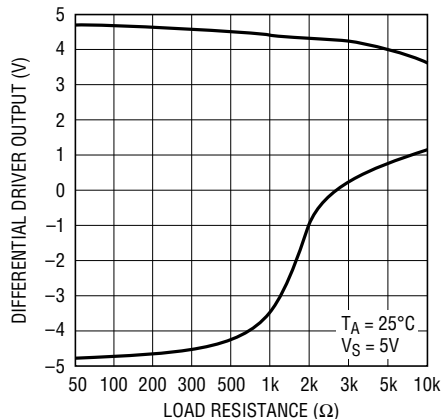
TYPICAL PERFORMANCE CHARACTERISTICS

**Charge Pump Output Voltage
vs Load Current**



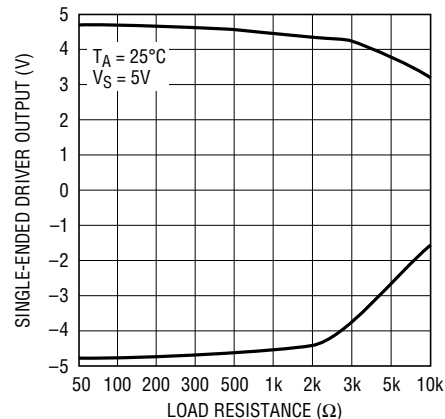
LTC1323 • TPC01

**Differential Driver Swing
vs Load Resistance**



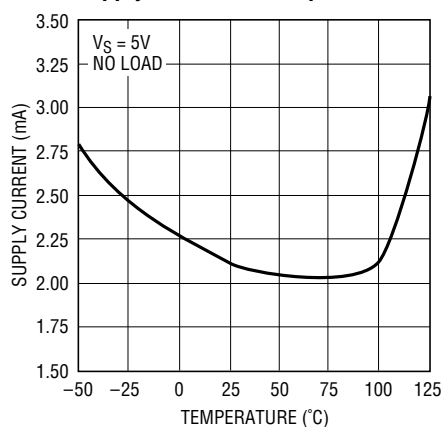
LTC1323 • TPC02

**Single-Ended Driver Swing
vs Load Resistance**



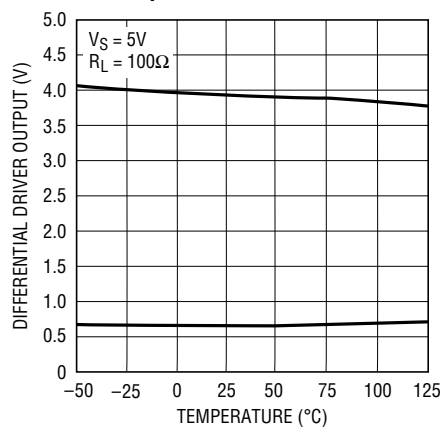
LTC1323 • TPC03

Supply Current vs Temperature



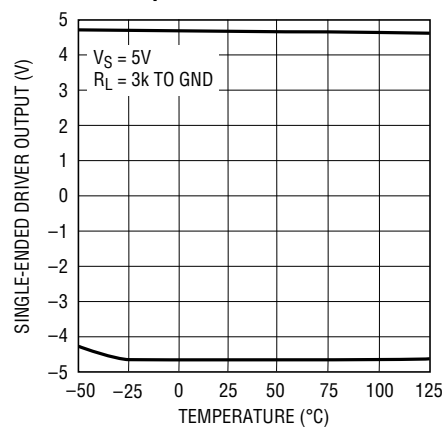
LTC1323 • TPC04

**Differential Driver Swing
vs Temperature**



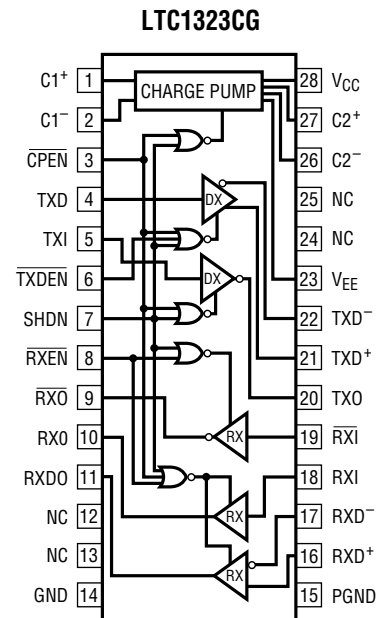
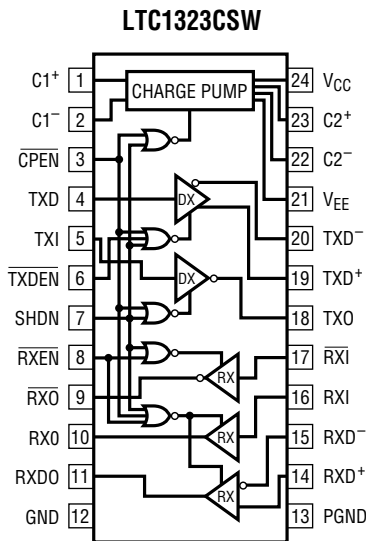
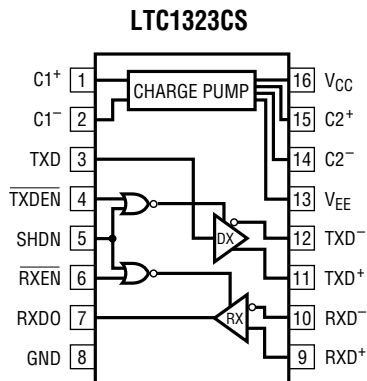
LTC1323 • TPC05

**Single-Ended Driver Swing
vs Temperature**



LTC1323 • TPC06

PIN FUNCTIONS



C1⁺: C1 Positive Input. Connect a 0.33μF capacitor between C1⁺ and C1⁻.

C1⁻: C1 Negative Input. Connect a 0.33μF capacitor between C1⁺ and C1⁻.

CPEN: TTL Level Charge Pump Enable Input. With $\overline{\text{CPEN}}$ held low, the charge pump is enabled and the chip operates normally. When $\overline{\text{CPEN}}$ is pulled high, the charge pump is disabled as well as both drivers, the noninverting single-ended receiver, and the differential receiver. The inverting single-ended receiver (RXI) is kept alive to monitor the control line and I_{CC} drops to 65μA. To turn off the receiver and drop I_{CC} to 0.5μA, pull the SHDN pin high.

TXD: Differential Driver Input (TTL compatible).

TXI: Single-Ended Driver Input (TTL compatible).

TXDEN: Differential Driver Output Enable (TTL compatible). A high level on this pin forces the differential driver into three-state; a low level enables the driver. This input does not affect the single-ended driver.

SHDN: Shutdown Input (TTL compatible). When this pin is high, the chip is shut down. All driver and receiver outputs are three-state, the charge pump turns off, and the supply current drops to 0.5μA. A low level on this pin allows normal operation.

RXEN: Receiver Enable (TTL compatible). A high level on this pin disables the receivers and three-states the logic outputs; a low level allows normal operation.

RXO: Inverting Single-Ended Receiver Output. Remains active in the receiver keep-alive mode.

RXO: Noninverting Single-Ended Receiver Output.

RXDO: Differential Receiver Output.

GND: Signal Ground. Connect to PGND with 24-pin package.

PGND: Power ground is connected internally to the charge pump and differential driver. Connect to the GND pin.

RXD⁺: Differential Receiver Noninverting Input. When this pin is $\geq 200\text{mV}$ above RXD^- , RXDO will be high; when this pin is $\geq 200\text{mV}$ below RXD^- , RXDO will be low.

RXD⁻: Differential Receiver Inverting Input.

RXI: Noninverting Receiver Input. This input controls the RXO output.

RXI: Inverting Receiver Input. This input controls the $\overline{\text{RXO}}$ output. In receiver keep-alive mode (CPEN high, SHDN low), this receiver can be used to monitor a wake-up control signal.

PIN FUNCTIONS

TX0: Single-Ended Driver Output.

TXD⁺: Differential Driver Noninverting Output.

TXD⁻: Differential Driver Inverting Output.

V_{EE}: Negative Supply Charge Pump Output. Requires a 1 μ F bypass capacitor to ground. If an external load is connected to the V_{EE} pin, the bypass capacitor value should be increased to 4.7 μ F.

C2⁻: C2 Negative Input. Connect a 0.33 μ F capacitor between C2⁺ and C2⁻.

C2⁺: C2 Positive Input. Connect a 0.33 μ F capacitor between C2⁺ and C2⁻.

V_{CC}: Positive Supply Input. $4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$. Requires a 1 μ F bypass capacitor to ground.

TEST CIRCUITS

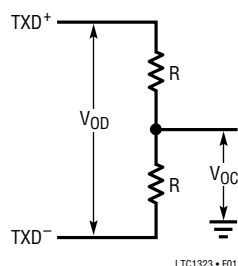


Figure 1

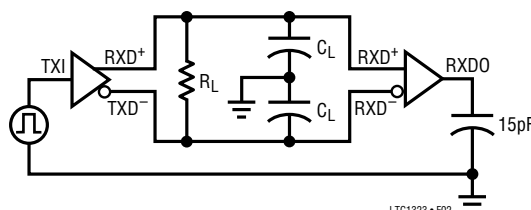


Figure 2

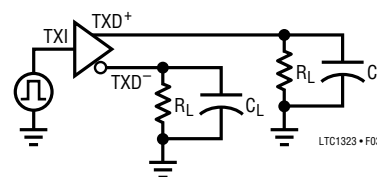


Figure 3

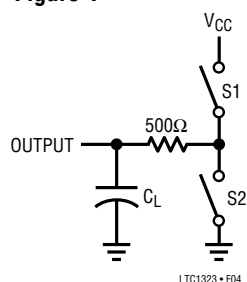


Figure 4

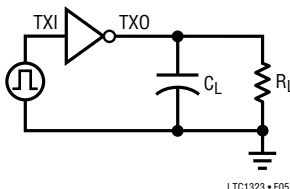


Figure 5

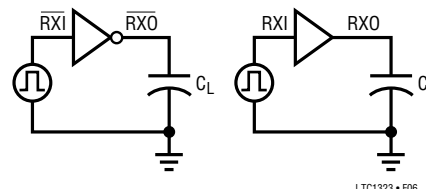


Figure 6

SWITCHING WAVEFORMS

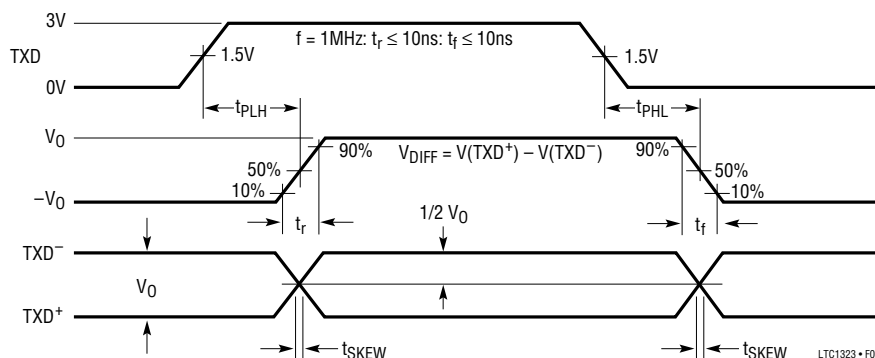
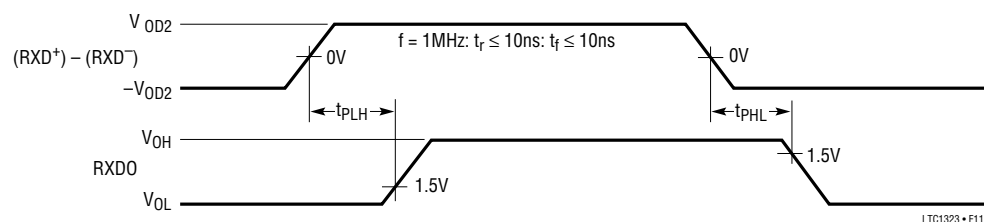
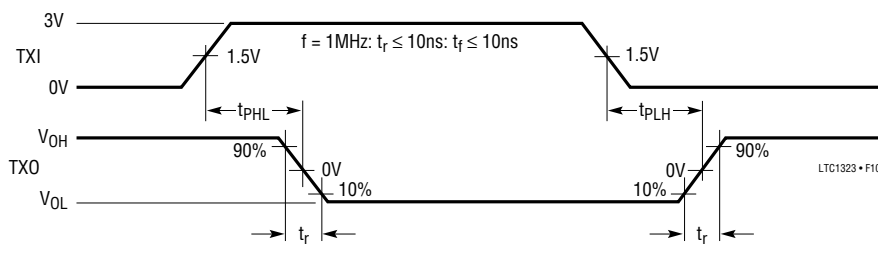
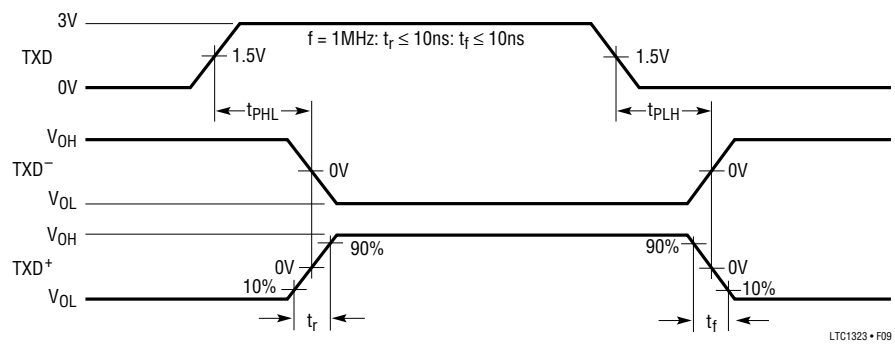
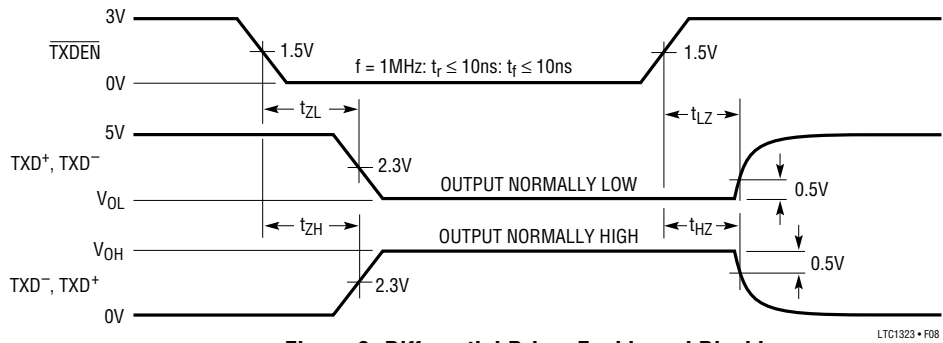
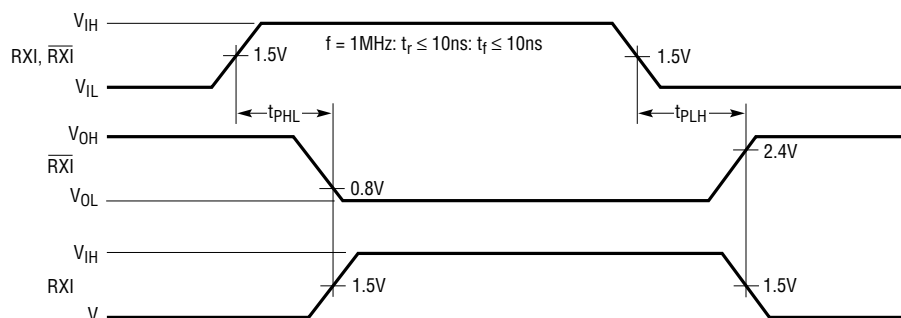


Figure 7. Differential Driver

SWITCHING WAVEFORMS

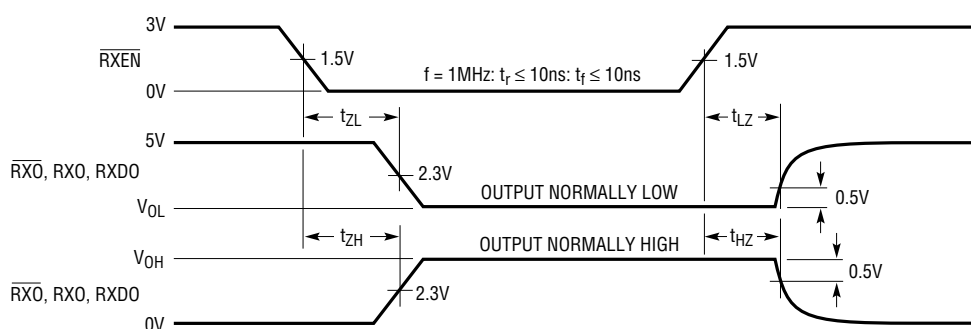


SWITCHING WAVEFORMS



LTC1323 • F12

Figure 12. Single-Ended Receiver



LTC1323 • F13

Figure 13. Receiver Enable and Disable

APPLICATIONS INFORMATION

Functional Description

The “serial port” on the back of an Apple-compatible computer or peripheral is a fairly versatile “multi-protocol” connector. It must be able to connect to a wide bandwidth LAN (an AppleTalk/LocalTalk network), which requires a high speed differential transceiver to meet the AppleTalk specification, and it must also be able to connect directly to a printer or modem through a short RS232 style link. The LTC1323 is designed to provide all the functions necessary to implement such a port on a single chip. Two versions of the LTC1323 are available: a 16-pin SO version which provides the minimum solution for interfacing to an AppleTalk network in a smaller package, and a larger 24-pin SO Wide version which additionally includes all the handshaking lines required to implement a complete AppleTalk/modem/printer serial port. All LTC1323s run from a single 5V power supply while providing true single-ended compatibility, and include a 0.5μA low power shutdown mode

to improve lifetime in battery-powered devices. The 24-pin SO Wide version also includes a receiver keep-alive mode for monitoring external signals while drawing 65μA typically.

The LTC1323 includes an RS422-compatible differential driver/receiver pair for data transmission, with the driver specified to drive 2V into the 100Ω primary of a typical LocalTalk interface transformer/RFI interference network. Either output of the differential RS422 driver can also act as a single-ended driver, allowing the LTC1323 to communicate over a standard serial connection. The 24-pin SO Wide LTC1323 also includes an extra single ended only driver and two extra RS232-compatible single-ended receivers for handshaking lines. All versions include an on-board charge pump to provide a regulated -5V supply required for the single-ended drivers. The charge pump can also provide up to 10mA of external load current to power other circuitry.

APPLICATIONS INFORMATION

Driving Differential AppleTalk or Single-Ended Loads

The differential driver is able to drive either an AppleTalk load or a single-ended load such as a printer or modem. With a differential AppleTalk load, TXD⁺ and TXD⁻ will typically swing between 1.2V and 3.5V (Figure 14a). With a single-ended 3k load such as a printer, either TXD⁺ or TXD⁻ will meet the single-ended voltage swing requirement of $\pm 3.7V$ (Figure 14b). An automatic switching circuit prevents the differential driver from overloading the charge pump if the outputs are shorted to ground while driving single-ended signals. This allows the second single-ended driver to continue to operate normally when the first is shorted, and allows external circuitry attached to the charge pump output to continue to operate even if there are faults at the driver outputs.

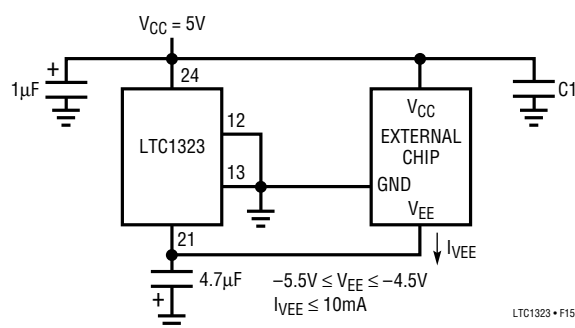


Figure 14

Thermal Shutdown Protection

The LTC1323 includes a thermal shutdown circuit which protects against prolonged shorts at the driver outputs. If a driver output is shorted to another output or to the power supply, the current will be initially limited to a maximum of 500mA. When the die temperature rises above 150°C, the thermal shutdown circuit disables the driver outputs. When the die cools to about 130°C, the outputs are re-enabled. If the short still exists, the part will heat again and the cycle will repeat. This oscillation occurs at about 10Hz and prevents the part from being damaged by excessive power dissipation. When the short is removed, the part will return to normal operation.

Power Shutdown

The power shutdown feature of the LTC1323 is designed for battery-powered systems. When SHDN is forced high the part enters shutdown mode. In shutdown the supply current typically drops from 2.4mA to 0.5μA, the charge pump turns off, and the driver and receiver outputs are three-stated.

Receiver Keep-Alive Mode (24-Pin SO Wide Only)

The 24-pin SO Wide version of the LTC1323 also features a power saving receiver keep-alive mode. When \overline{CPEN} is pulled high the charge pump is turned off and the outputs of both drivers, the noninverting single-ended receiver and the differential receiver are forced into three-state. The inverting single-ended receiver (RXI) is kept alive with I_{CC} dropping to 65μA and the receiver delay time increasing to a maximum of 400ns. The receiver can then be used to monitor a wake-up control signal.

Charge Pump Capacitors and Supply Bypassing

The LTC1323 requires two external 0.33μF capacitors for the charge pump to operate: one from C1⁺ to C1⁻ and one from C2⁺ to C2⁻. These capacitors should be low ESR types and should be mounted as close as possible to the LTC1323. Monolithic ceramic capacitors work well in this application. Do not use capacitors greater than 2μF at the charge pump pins or internal peak currents can rise to destructive levels. The LTC1323 also requires that both VCC and VEE be well bypassed to ensure proper charge pump operation and prevent data errors. A 1μF capacitor from VCC to ground is adequate. A 1μF capacitor is required from VEE to ground and should be increased to 4.7μF if an external load is connected to the VEE pin. Ceramic or tantalum capacitors are adequate for power supply bypassing; aluminum electrolytic capacitors should only be used if their ESR is low enough for proper charge pump operation. Inadequate bypass or charge pump capacitors will cause the charge pump output to go out of regulation prematurely, degrading the output swing at the SINGLE-ENDED driver outputs.

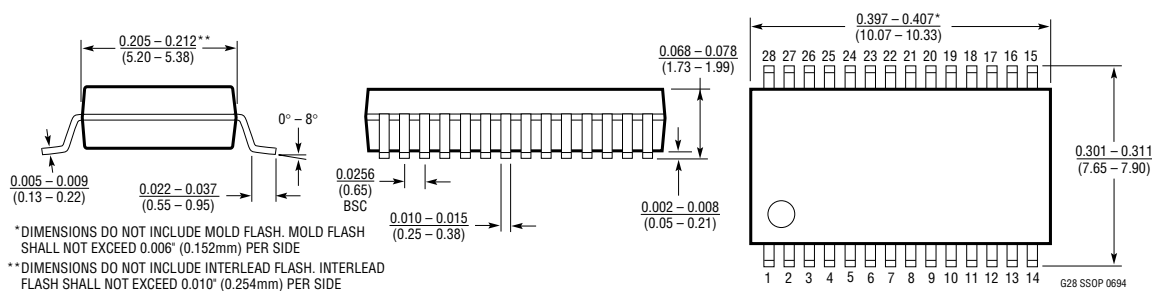
PACKAGE DESCRIPTION

Dimensions in inches (millimeters) unless otherwise noted.

G Package

28-Lead Plastic SSOP (0.209)

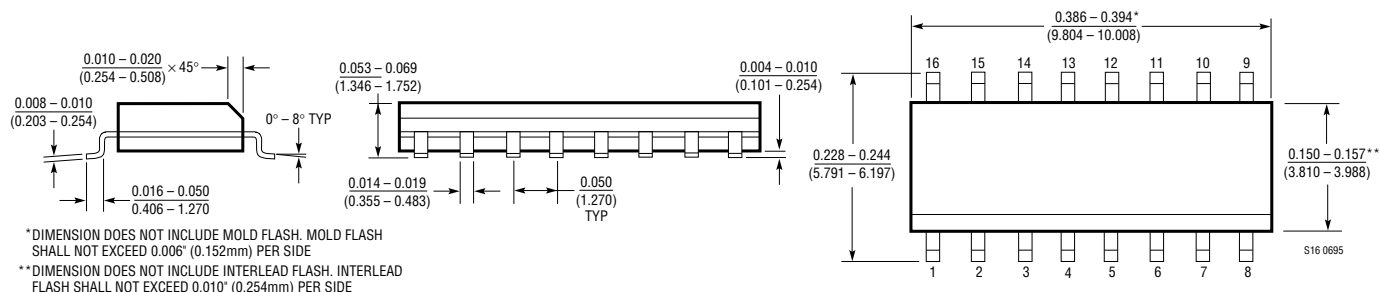
(LTC DWG # 05-08-1640)



S Package

16-Lead Plastic Small Outline (Narrow 0.150)

(LTC DWG # 05-08-1610)



SW Package

24-Lead Plastic Small Outline (Wide 0.300)

(LTC DWG # 05-08-1620)

